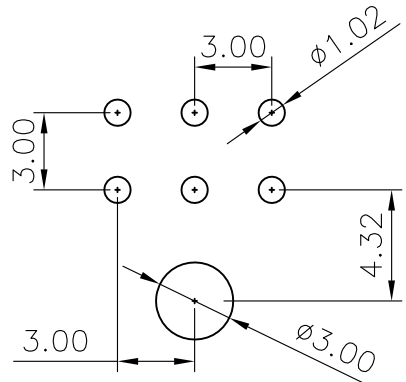
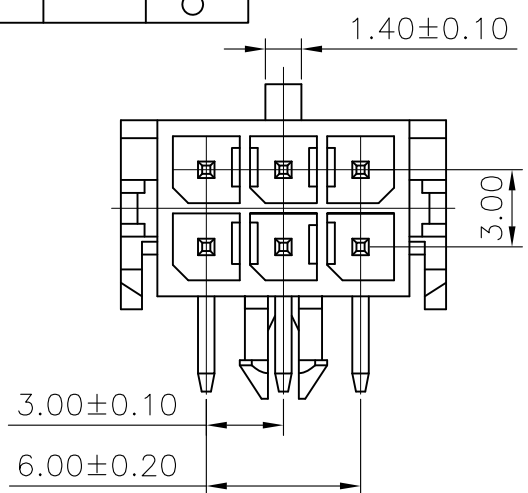
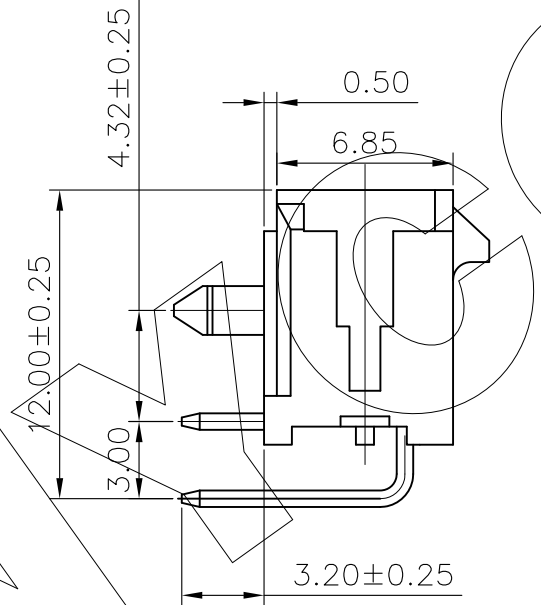
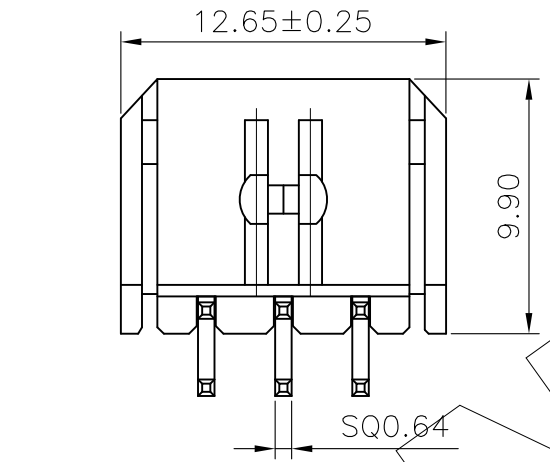


零件图	成品图	客户图
		○

REVISION DATA				
REV	ECN No.	DESCRIPTION	NAME	DATE
A0		NEW DRAWING	Zhang	2017-11-06



P.C.B LAYOUT



Technical Data

Material:
 Contact Material: Copper Alloy
 Contact plating: Au or Sn Over Ni
 Insulator Material: See the table, UL94 V-0

Electrical:
 Rating current: 3Amps/contact max.
 Rating voltage : 250 V AC/DC
 Contact resistance: ≤20mΩ/contact
 Insulation resistance: ≥1000MΩ
 Withstanding Voltage: 1000V AC/minute

Mechanical:
 Operating temperatures: Gold Plated: -55°C to +105°C
 Tin plated: -40°C to +105°C
 Soldering temperature: +260°C, max(PA66)
 +220°C, max(PBT)

WF	F	R	12	006	XX	X	L	R003
Pitch(mm) A 2.5 B 2.0 C 1.25 D 3.96 E 2.54 F 3.0 G 1.0	Angel Options R 90° D 180° S SMT	Product Type 12 Double row	No. of Positions 006 Poles	Pin Plating G0 Gold Flash SN Tin Plated	Insulator Material A PBT B PA66 C PA6T D LCP E PA46 F PA9T	W With peg N NO Peg L with lock T Fixed Tabs	Series NO. R003	

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DONGGUAN ENKANG ELECTRONICS TECHNOLOGY CO.,LTD

TOLERANCE	DATE :	2017-11-06	TITLE:				
ANGLE ±5°	DRAWN :	Zhang	PH3.00 H9.85 W7.36 90° DIP WAFER				
X.XXX ±0.15	CHECKED :		PART NO: WFFR12006XXXLR003				
X.XX ±0.25	APPROVED :						
X.X ±0.40	PROJECTON		REV: A0	UNIT: mm	SCALE: 1:1	SIZE: A4	PAGE: 1/1
X. ±0.50							